

Molding Type Module IGBT, 2-in-1 Package, 1200 V and 300 A



Double INT-A-PAK

FEATURES

- 10 μ s short circuit capability
- $V_{CE(on)}$ with positive temperature coefficient
- Maximum junction temperature 150 °C
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRODUCT SUMMARY	
V_{CES}	1200 V
I_C at $T_C = 80\text{ °C}$	300 A
$V_{CE(on)}$ (typical) at $I_C = 300\text{ A}$, 25 °C	2.00 V
Speed	8 kHz to 30 kHz
Package	Double INT-A-PAK
Circuit	Half bridge

TYPICAL APPLICATIONS

- UPS
- Inverter for motor drive
- AC and DC servo drive amplifier

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		1200	V
Gate to emitter voltage	V_{GES}		± 20	
Collector current	I_C	$T_C = 25\text{ °C}$	500	A
		$T_C = 80\text{ °C}$	300	
Pulsed collector current	$I_{CM}^{(1)}$	$t_p = 1\text{ ms}$	600	
Diode continuous forward current	I_F	$T_C = 80\text{ °C}$	300	
Diode maximum forward current	I_{FM}	$t_p = 1\text{ ms}$	600	
Maximum power dissipation	P_D	$T_J = 150\text{ °C}$	1645	
Short circuit withstand time	t_{SC}	$T_J = 125\text{ °C}$	10	μ s
RMS isolation voltage	V_{ISOL}	$f = 50\text{ Hz}$, $t = 1\text{ min}$	2500	V

Note

⁽¹⁾ Repetitive rating; pulse width limited by maximum junction temperature.



IGBT ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	T _J = 25 °C	1200	-	-	V
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 300 A, T _J = 25 °C	-	2.00	2.45	
		V _{GE} = 15 V, I _C = 300 A, T _J = 125 °C	-	2.20	-	
Gate to emitter threshold voltage	V _{GE(th)}	V _{CE} = V _{GE} , I _C = 12 mA, T _J = 25 °C	5.0	6.2	7.0	
Collector cut-off current	I _{CES}	V _{CE} = V _{CES} , V _{GE} = 0 V, T _J = 25 °C	-	-	5.0	mA
Gate to emitter leakage current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V, T _J = 25 °C	-	-	400	nA

SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t _{d(on)}	V _{CC} = 600 V, I _C = 300 A, R _g = 4.7 Ω, V _{GE} = ± 15 V, T _J = 25 °C	-	574	-	ns
Rise time	t _r		-	133	-	
Turn-off delay time	t _{d(off)}		-	563	-	
Fall time	t _f		-	120	-	
Turn-on switching loss	E _{on}	V _{CC} = 600 V, I _C = 300 A, R _g = 4.7 Ω, V _{GE} = ± 15 V, T _J = 125 °C	-	23.9	-	mJ
Turn-off switching loss	E _{off}		-	25.3	-	
Turn-on delay time	t _{d(on)}		-	604	-	
Rise time	t _r		-	137	-	
Turn-off delay time	t _{d(off)}	V _{CC} = 600 V, I _C = 300 A, R _g = 4.7 Ω, V _{GE} = ± 15 V, T _J = 125 °C	-	629	-	ns
Fall time	t _f		-	167	-	
Turn-on switching loss	E _{on}		-	31.5	-	
Turn-off switching loss	E _{off}		-	35.9	-	
Input capacitance	C _{ies}	V _{GE} = 0 V, V _{CE} = 25 V, f = 1.0 MHz	-	21.2	-	nF
Output capacitance	C _{oes}		-	1.42	-	
Reverse transfer capacitance	C _{res}		-	0.94	-	
SC data	I _{SC}	t _{sc} ≤ 10 μs, V _{GE} = 15 V, T _J = 125 °C, V _{CC} = 900 V, V _{CEM} ≤ 1200 V	-	1800	-	A
Internal gate resistance	R _{gint}		-	1.0	-	Ω
Stray inductance	L _{CE}		-	-	20	nH
Module lead resistance, terminal to chip	R _{CC'+EE'}	T _C = 25 °C	-	0.35	-	mΩ

DIODE ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Diode forward voltage	V _F	I _F = 300 A	T _J = 25 °C	-	1.82	2.25	V
			T _J = 125 °C	-	1.95	-	
Diode reverse recovery charge	Q _{rr}	I _F = 300 A, V _R = 600 V, di/dt = -2360 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	20.2	-	μC
			T _J = 125 °C	-	40.1	-	
Diode peak reverse recovery current	I _{rr}	I _F = 300 A, V _R = 600 V, di/dt = -2360 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	170	-	A
			T _J = 125 °C	-	250	-	
Diode reverse recovery energy	E _{rec}	I _F = 300 A, V _R = 600 V, di/dt = -2360 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	8.2	-	mJ
			T _J = 125 °C	-	21.7	-	



THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature range	T_J		-	-	150	°C
Storage temperature range	T_{STG}		-40	-	125	
Junction to case	IGBT	R_{thJC}	-	-	0.076	K/W
	Diode		-	-	0.100	
Case to sink	R_{thCS}	Conductive grease applied	-	0.035	-	
Mounting torque		Power terminal screw: M6	2.5 to 5.0			Nm
		Mounting screw: M6	3.0 to 5.0			
Weight			300			g

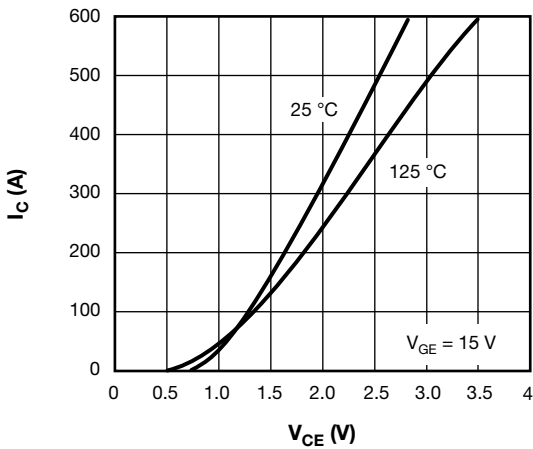


Fig. 1 - IGBT Typical Output Characteristics

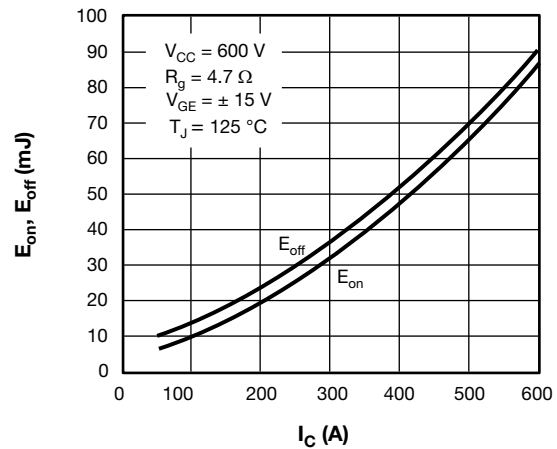


Fig. 3 - IGBT Switching Loss vs. I_C

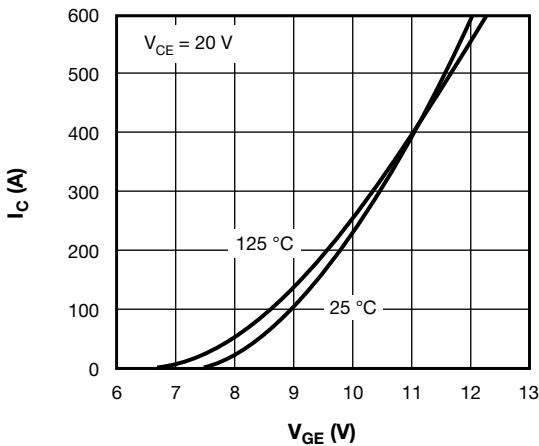


Fig. 2 - IGBT Typical Transfer Characteristics

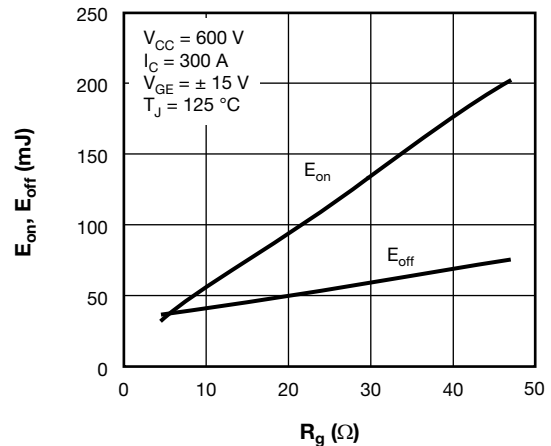


Fig. 4 - IGBT Switching Loss vs. R_g

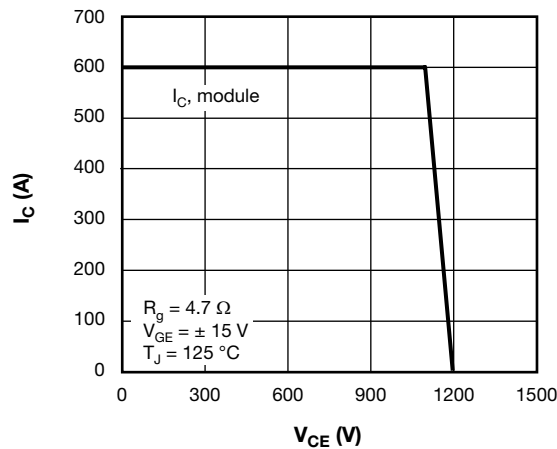


Fig. 5 - RBSOA

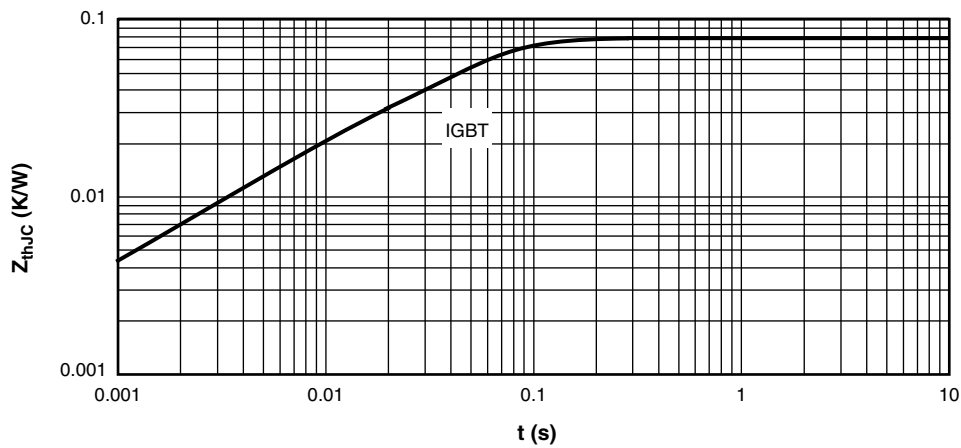


Fig. 6 - IGBT Transient Thermal Impedance

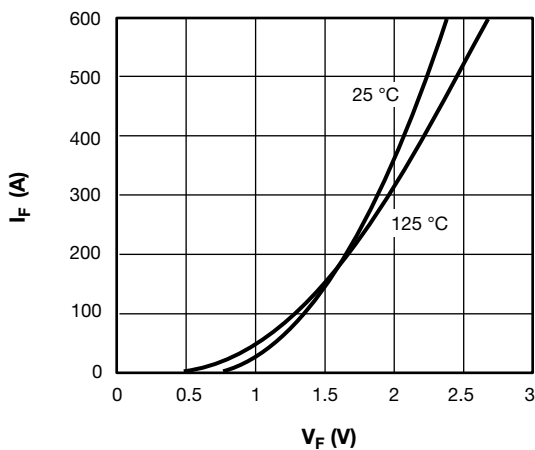


Fig. 7 - Typical Forward Characteristics

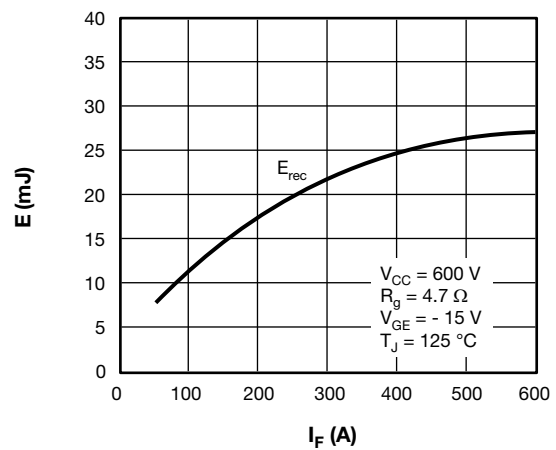


Fig. 8 - Diode Switching Loss vs. I_F

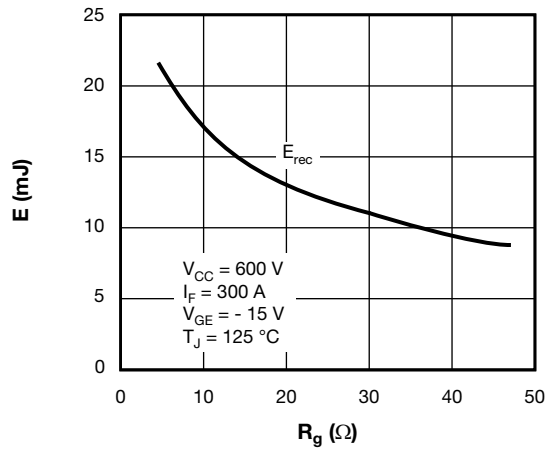


Fig. 9 - Diode Switching Loss vs. Gate Resistance R_g

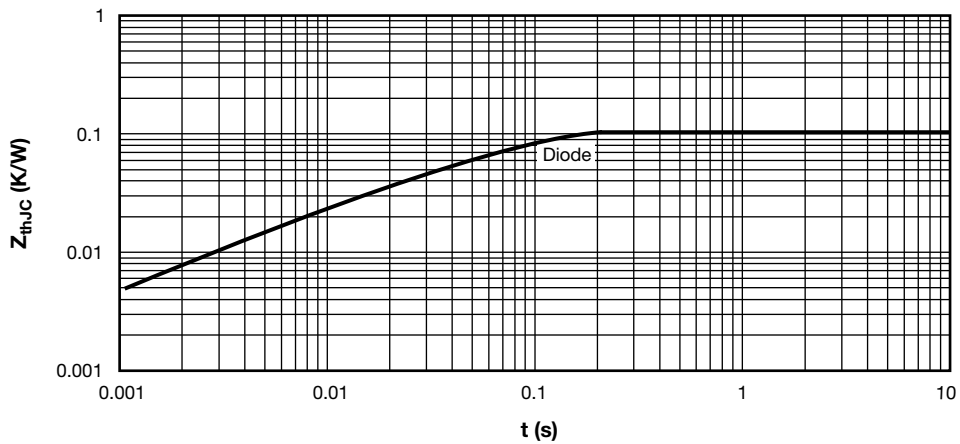
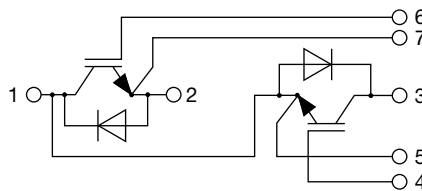


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION



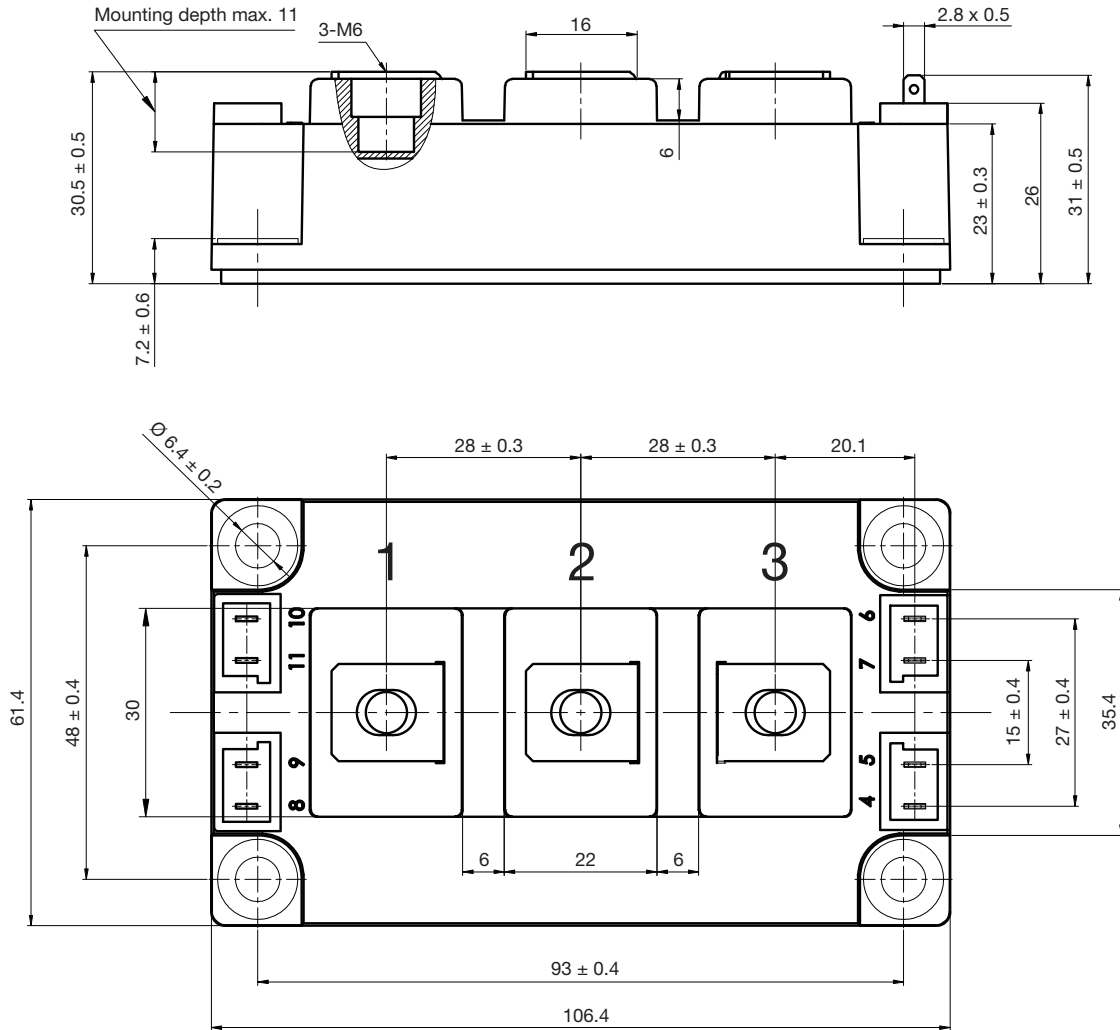
LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95525
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Double INT-A-PAK

DIMENSIONS in millimeters (inches)





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